### **General Description**

The SJH050N03A uses SGT technology to provide excellent R<sub>DS(ON)</sub>, low gate charge and fast switching characteristics. This device is suitable for use as a wide variety of applications.

#### **Features**

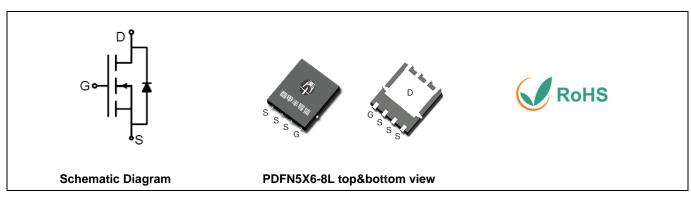
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handing capability
- Lead free product is acquired

### **Application**

- DC/DC Converter
- Load Switching, Quick/Wireless Charging, Motor Driving

### **Key Performance Parametes**

| Parameter               | Value | Unit |
|-------------------------|-------|------|
| V <sub>DS</sub>         | 30    | ٧    |
| R <sub>DS(ON)_TYP</sub> | 4.8   | mΩ   |
| I <sub>D</sub>          | 70    | Α    |
| Q <sub>G</sub>          | 12.6  | nC   |



### **Package Marking and Ordering Information**

| Device/Ordering Code | Marking    | Package    | Packing | Reel Size | Tape width | Quantity |
|----------------------|------------|------------|---------|-----------|------------|----------|
| SJH050N03A           | SJH050N03A | PDFN5X6-8L | Tape    | \         | \          | 5000 Pcs |

### Table 1. Absolute Maximum Ratings (T<sub>C</sub>=25℃ unless otherwise noted)

| Symbol                  | Parameter  | Limit      | Unit |
|-------------------------|--|------------|------|
| V <sub>DS</sub>         | Drain-Source Voltage (V <sub>GS</sub> =0V)                       | 30         | V    |
| V <sub>G</sub> S        | Gate-Source Voltage (V <sub>DS</sub> =0V)                        | ±20        | V    |
| 1                       | Drain Current-Continuous(Tc=25°C)                                | 70         | А    |
| ID                      | I <sub>D</sub> Drain Current-Continuous(T <sub>C</sub> =100℃)    |            | А    |
| I <sub>DM</sub> (pluse) | Drain Current-Continuous@ Current-Pulsed (Note 1)                | 280        | А    |
| -                       | Maximum Power Dissipation(Tc=25℃)                                | 48         | W    |
| PD                      | P <sub>D</sub> Maximum Power Dissipation(T <sub>C</sub> =100 °C) |            | W    |
| E <sub>AS</sub>         | Avalanche energy (Note 2)  | 81         | mJ   |
| TJ, TSTG                | Operating Junction and Storage Temperature Range                 | -55 To 150 | °C   |

### Table 2. Thermal Characteristic

| Symbol  | Parameter | Тур | Max | Unit |
|---|-----------|-----|-----|------|
| R <sub>0JC</sub> Thermal Resistance, Junction-to-Case |           |     | 2.6 | °C/W |



Table 3. Electrical Characteristics (T<sub>J</sub>=25℃ unless otherwise noted)

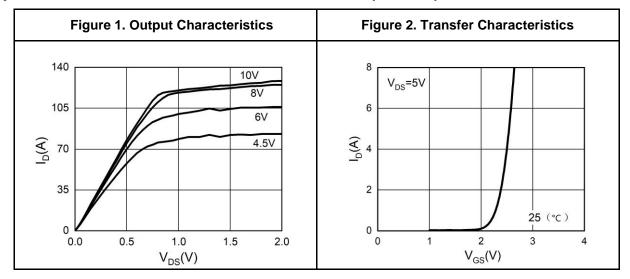
| Symbol               | Parameter                         | Conditions   | Min | Тур  | Max  | Unit |
|----------------------|-----------------------------------|--|-----|------|------|------|
| On/Off States        | •                                 |  |     |      |      |      |
| BV <sub>DSS</sub>    | Drain-Source Breakdown Voltage    | V <sub>GS</sub> =0V I <sub>D</sub> =250μA                                  | 30  |      |      | V    |
|                      | 7 0 1 1/1 1 5 1 0 1               | V <sub>DS</sub> =30V, V <sub>GS</sub> =0V T <sub>J</sub> =25℃              |     |      | 1    | μA   |
| I <sub>DSS</sub>     | Zero Gate Voltage Drain Current   | V <sub>DS</sub> =30V, V <sub>GS</sub> =0V T <sub>J</sub> =125°C            |     |      | 100  | μA   |
| Igss                 | Gate-Body Leakage Current         | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                                 |     |      | ±100 | nA   |
| V <sub>GS(th)</sub>  | Gate Threshold Voltage            | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA                   | 1.0 |      | 2.5  | V    |
| <b>g</b> FS          | Forward Transconductance          | V <sub>DS</sub> =5V, I <sub>D</sub> =20A                                   |     | 64   |      | S    |
|                      |                                   | V <sub>GS</sub> =10V, I <sub>D</sub> =20A T <sub>J</sub> =25°C             |     | 4.8  | 6    | mΩ   |
| R <sub>DS</sub> (ON) | Drain-Source On-State Resistance  | V <sub>GS</sub> =4.5V, I <sub>D</sub> =20A T <sub>J</sub> =25°C            |     | 6.5  | 8.5  | mΩ   |
| Dynamic Chara        | octeristics                       |  |     | •    |      |      |
| Ciss                 | Input Capacitance                 |  |     | 884  |      | pF   |
| Coss                 | Output Capacitance                | V <sub>DS</sub> =15V,V <sub>GS</sub> =0V,<br>f=1.0MHz                      |     | 236  |      | pF   |
| Crss                 | Reverse Transfer Capacitance      |  |     | 17   |      | pF   |
| Rg                   | Gate resistance                   | V <sub>GS</sub> =0V, V <sub>DS</sub> =0V, f=1.0MHz                         |     | 3.6  |      | Ω    |
| Switching Para       | meters                            |  |     | •    |      |      |
| t <sub>d(on)</sub>   | Turn-on Delay Time                |  |     | 7    |      | nS   |
| tr                   | Turn-on Rise Time                 | $V_{GS}$ =10V, $V_{DS}$ =15V, $R_L$ =0.75 $\Omega$ , $R_{GEN}$ =3 $\Omega$ |     | 4    |      | nS   |
| t <sub>d(off)</sub>  | Turn-Off Delay Time               |  |     | 19   |      | nS   |
| t <sub>f</sub>       | Turn-Off Fall Time                |  |     | 3    |      | nS   |
| Qg                   | Total Gate Charge                 |  |     | 12.6 |      | nC   |
| Qgs                  | Gate-Source Charge                | V <sub>GS</sub> =10V, V <sub>DS</sub> =15V, I <sub>D</sub> =20A            |     | 3    |      | nC   |
| $Q_{gd}$             | Gate-Drain Charge                 |  |     | 1.8  |      | nC   |
| Source-Drain D       | Piode Characteristics             |  |     | •    |      | •    |
| I <sub>SD</sub>      | Source-Drain Current (Body Diode) |  |     |      | 70   | А    |
| V <sub>SD</sub>      | Forward on Voltage (Note 3)       | V <sub>GS</sub> =0V, I <sub>S</sub> =20A                                   |     |      | 1.2  | V    |
| t <sub>rr</sub>      | Reverse Recovery Time             | I <sub>F</sub> =20A, dI/dt=100A/μs   |     | 11   |      | ns   |
| Qrr                  | Reverse Recovery Charge           | I <sub>F</sub> =20A, dI/dt=100A/μs   |     | 20   |      | nC   |

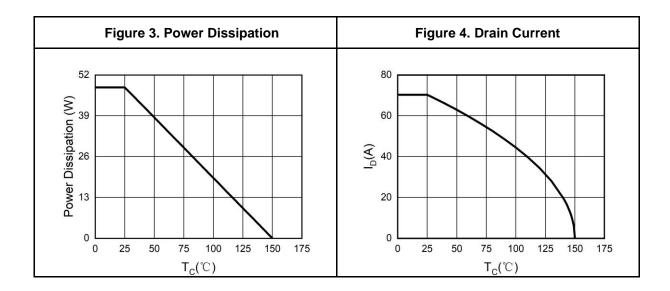
Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

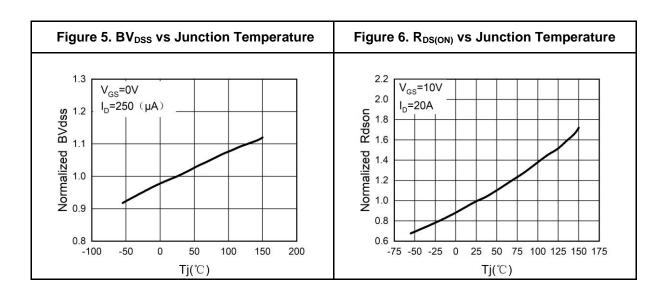
Notes 2.E<sub>AS</sub> condition:  $T_J=25^{\circ}C$ ,  $V_{DD}=30V$ ,  $V_G=10V$ ,  $Rg=25\Omega$ , L=0.5mH.

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.

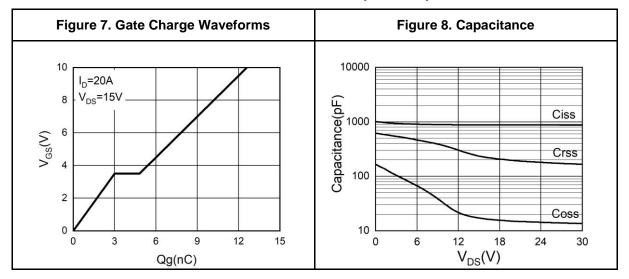
## **Typical Electrical And Thermal Characteristics (Curves)**

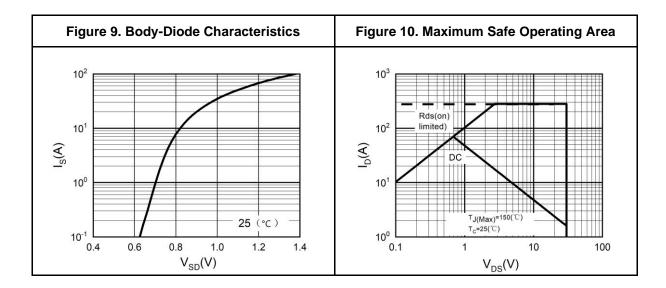






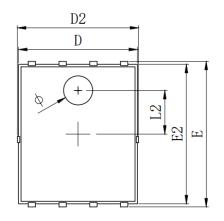
## **Typical Electrical And Thermal Characteristics (Curves)**

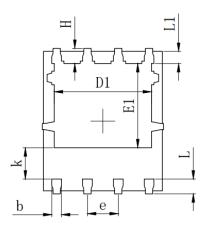




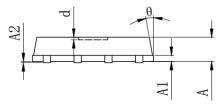


# PDFN5X6-8L Package Information





| CIAMOI |            | MILLIMETER  |        |  |
|--------|------------|-------------|--------|--|
| SYMBOL | MIN        | Тур.        | MAX    |  |
| A      | 0. 900     | 1.000       | 1. 100 |  |
| A1     |            | 0. 254 REF. |        |  |
| A2     |            | 0~0.05      |        |  |
| D      | 4. 824     | 4. 900      | 4. 976 |  |
| D1     | 3. 910     | 4. 010      | 4. 110 |  |
| D2     | 4. 924     | 5. 000      | 5. 076 |  |
| E      | 5. 924     | 6.000       | 6. 076 |  |
| E1     | 3. 375     | 3. 475      | 3. 575 |  |
| E2     | 5. 674     | 5. 750      | 5. 826 |  |
| b      | 0. 350     | 0.400       | 0.450  |  |
| e      | 1.270 TYP. |             |        |  |
| L      | 0. 534     | 0.610       | 0. 686 |  |
| L1     | 0. 424     | 0. 500      | 0. 576 |  |
| L2     | 1.800 REF. |             |        |  |
| k      | 1. 190     | 1. 290      | 1. 390 |  |
| Н      | 0. 549     | 0. 625      | 0. 701 |  |
| θ      | 8°         | 10°         | 12°    |  |
| ф      | 1.100      | 1. 200      | 1.300  |  |
| d      |            |             | 0. 100 |  |



| Symbol | MILLIMETER |            |       |  |  |  |
|--------|------------|------------|-------|--|--|--|
|        | Min.       | Тур.       | Max.  |  |  |  |
| Α      | 0.900      | 1.000      | 1.100 |  |  |  |
| A1     |            | 0.254 REF. |       |  |  |  |
| A2     |            | 0~0.05     |       |  |  |  |
| D      | 4.824      | 4.900      | 4.976 |  |  |  |
| D1     | 3.910      | 4.010      | 4.110 |  |  |  |
| D2     | 4.924      | 5.000      | 5.076 |  |  |  |
| Е      | 5.924      | 6.000      | 6.076 |  |  |  |
| E1     | 3.375      | 3.475      | 3.575 |  |  |  |
| E2     | 5.674      | 5.75       | 5.826 |  |  |  |
| b      | 0.350      | 0.400      | 0.450 |  |  |  |
| е      | 1.270 TYP. |            |       |  |  |  |
| L      | 0.534      | 0.610      | 0.686 |  |  |  |
| L1     | 0.424      | 0.500      | 0.576 |  |  |  |
| L2     |            | 1.800 REF. |       |  |  |  |
| k      | 1.190      | 1.290      | 1.390 |  |  |  |
| Н      | 0.549      | 0.625      | 0.701 |  |  |  |
| θ      | 8°         | 10°        | 12°   |  |  |  |
| Ф      | 1.100      | 1.200      | 1.300 |  |  |  |
| d      |            |            | 0.100 |  |  |  |



#### Attention

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